



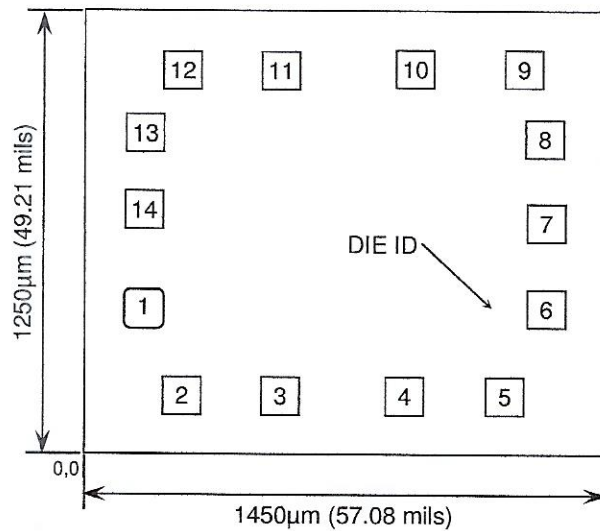
Sierra Components, Inc.

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Rev 1.0
15/03/18

Pad Layout and Functions



PAD	FUNCTION	COORDINATES (mm)	
		X	Y
1	A	0.1160	0.3630
2	B	0.2185	0.1160
3	D	0.4915	0.1160
4	E	0.8445	0.1160
5	F	1.1175	0.1160
6	K	1.2340	0.3630
7	V _{SS}	1.2340	0.6065
8	C	1.2340	0.8405
9	J	1.1175	1.0340
10	L	0.8705	1.0340
11	I	0.4915	1.0340
12	H	0.2185	1.0340
13	G	0.1160	0.8515
14	V _{DD}	0.1160	0.6410

CONNECT CHIP BACK TO V_{DD} OR FLOAT

Topside Metal: (AL)
Backside Metal: (Si)
Backside Potential: V_{DD} or Float
Bond Pad Size: .004" x .004" min

APPROVED BY: MG

DIE SIZE: 57 x 49 Mils

DATE: 3/16/18

MFG: Silicon Supplies THICKNESS: 13.8 Mils

P/N: CD4073B